HUAWEI FusionServer X6800 Data Center Server





HUAWEI TECHNOLOGIES CO., LTD.

HUAWEI FusionServer X6800 Data Center Server



As the IT infrastructure changes with the emergence and popularization of cloud computing and business models change with big data, high performance computing (HPC) has garnered intense interest. IT vendors are making efforts to provide more professional and flexible solutions and agile services. IT is becoming easy to obtain for IT users.

IT Infrastructure for Service Optimization

The world is embarking on an era of ICT convergence, which eliminates the computing upper limit, network boundaries, and storage limit to ensure efficient and agile applications and optimal user experience. By leveraging years of expertise in the IT industry and continuous innovation, Huawei has launched the new-generation FusionServer X6800. The X6800 features integrated high-density architecture, large storage capacity, and highly reliable management. It is an optimal choice for cloud computing, big data, and HPC applications.

In cloud computing, big data, and HPC applications, large-scale deployment, distributed storage and processing, and virtualization are distinguished features of IT. In addition, IT is mired in a constant battle to provide high performance, large storage capacity while attempting to control operational costs and hardware expenses.

The X6800 offers flexible configuration of a wide range of server nodes, meeting differentiated requirements for computing, storage, and I/O. The X6800 features high density and simplified system management and O&M. It is an optimal choice for enterprise IT infrastructure.

High Versatility

- Supports a variety of high-density server nodes in a 4U chassis.
- Allows flexible configuration of compute, storage, and GPU acceleration nodes to meet different service requirements.
- Provides large local storage space and supports SSD technologies, meeting requirements for high performance and large capacity.
- LOM network port supports 2 x GE, 4 x GE, 2 x 10GE, 2 x GE+2 x 10GE, 2 x 10GBase-T or 2 x 56G IB.

High Energy Efficiency

- Uses centralized power supply and heat dissipation and supports high-voltage DC, which minimizes the number of internal cables and heat loss.
- Uses 80 Plus Titanium power supply units (PSUs), which provide 96% power efficiency at 50% load.
- Uses optimized cooling design to maximize heat dissipation efficiency. The air intake vents on the panel increase cool air flows, and the air ducts isolate server nodes from power supplies, ensuring optimal heat dissipation.

Outstanding Stability and Reliability

- Uses a passive backplane to eliminate single points of failure (SPOFs).
- Supports long-term stable operating at 40°C.
- Implements server management using iBMC and HMM.
- Uses modular design and hot-swappable fan modules and PSUs in redundancy configuration.
- Allows cable-free installation and maintenance of server nodes.

Technical Specifications

Form factor	4U multi-node server
PCIe expansion	8 rear PCIe slots
PSU	Four redundant AC PSUs (750 W/1200 W/1500 W) or four redundant DC PSUs (800 W)
Fan	5 fan modules in N+1 redundancy
Management	Uses the HMM and iBMC for management, adopts the Huawei Hi1710 management chip, supports standard management interfaces, such as SNMP and IPMI, and provides the GUI, remote KVM, virtual media, SOL, intelligent power supply, remote control, and hardware monitoring. Supports Huawei eSight management software and provides remote configuration and deployment in batches, performance monitoring, and firmware upgrades.
Power supply	110 V to 220 V AC -48 V DC 240 V HVDC 380 V HVDC
Operating temperature	5°C to 40°C (41°F to 104°F)
Certifications	CE, UL, FCC and RoHS
Dimensions(H x W x D)	175 mm x 448 mm x 898 mm

HUAWEI FusionServer XH620 V3



The HUAWEI FusionServer XH620 V3 (XH620 V3 for short) is a fullheight dual-socket server node occupying one slot in an X6800 server. It uses the Intel[®] Xeon[®] E5-2600 v3/v4 series processors and supports 16 DDR4 lowvoltage DIMMs. The XH620 V3 is suited for applications that require high-density computing servers, such as web access, hosting, and virtualization, improving energy efficiency while saving space.

High Density

- The server nodes share the fan modules and PSUs in the chassis, minimizing space requirements.
- Eight XH620 V3 server nodes can be deployed in 4U space, saving up to 50% equipment footprint compared with 1 U rack servers.

Leading Performance

- Each XH620 V3 supports up to two Intel[®] Xeon[®] E5-2600 v3/v4 series processors that support a maximum frequency of 3.5 GHz and a maximum L3 cache capacity of 55 MB, proving excellent computing performance.
- A 4 U chassis can hold eight XH620 V3 server nodes that support up to 352 CPU cores and 704 threads. Each XH620 V3 supports Intel's hyper-threading technology, boosting performance for multithreaded applications.
- Each XH620 V3 supports 16 DDR4 DIMMs and supports the memory bandwidth of up to 153.6 GB/s, providing excellent data processing speed.

Flexible Configuration

- Each XH620 V3 supports a variety of LOMs, such as GE, 10GE, 10GBase-T, 56G IB NICs, without reconstructing the network.
- Each XH620 V3 can be configured with four hot-swappable 2.5-inch SSDs or SAS/SATA HDDs, two hot-swappable 2.5-inch SSDs or SAS/SATA HDDs and one HHHL PCIe 3.0 slot, or two non-hot-swappable 3.5-inch SAS/SATA HDDs, meeting various service requirements.

Technical Specifications

Form factor	Full-height dual-socket server node occupying one slot
Number of Processors	1 or 2
Processor	Intel® Xeon® E5-2600 v3/v4 processor
Memory	16 DDR4 DIMM slots
Local storage	Four or two 2.5-inch SSDs or SAS/SATA HDDs or two 3.5-inch SAS/SATA HDDs Two mini SSDs (SATA DOMs) One USB flash drive
LOM Network Ports	2 x GE, 4 x GE, 2 x 10GE, 2 x GE+2 x 10GE, 2 x 10GBase-T or 2 x 56G IB
PCIe Expansion	Up to 3 PCIe slots
OSs Supported	Citrix XenServer Microsoft Windows Server Oracle Enterprise Linux Oracle Server VM Red Hat Enterprise Linux SUSE Linux Enterprise Server VMware ESXi
Operating temperature*	5°C to 40°C (41°F to 104°F)
Certifications	CE, UL, FCC and RoHS
Dimensions(H x W x D)	166 mm x 54 mm x 670 mm

*Note: If the XH620 V3 is configured with two 2.5-inch or 3.5-inch hard disks, the operating temperature ranges from 5°C to 40°C, and if it is configured with four 2.5-inch hard disks, the operating temperature ranges from 5°C to 35°C.

HUAWEI FusionServer XH622 V3



The XH622 V3 is a full-height dual-socket server node occupying two slots in an X6800 server. It uses the Intel[®] Xeon[®] E5-2600 v3/ v4 series processors and supports 16 DDR4 memory slots and four 2.5-inch SSDs or SAS/SATA HDDs. An XH622 V3 provides up to two dual-slot GPGPUs or Xeon-Phi cards. The XH622 V3 server nodes can be used in Huawei ES3000 storage acceleration solution and apply to applications, such as HPC, graphics processing, and online games.

High Density

- The server nodes share the fan modules and PSUs in the chassis, minimizing space requirements.
- The 4U high-density architecture occupies 50% less space than a traditional 2U rack server.

Outstanding Performance

- Each XH622 V3 supports up to two Intel[®] Xeon[®] E5-2600 v3/v4 series processors, 44 cores, 88 threads, and two 9.6 GT/s QuickPath Interconnect (QPI) links between processors.
- A 4U server can hold four XH622 V3 nodes and 8 high-performance GPGPUs or Xeon-Phi cards, offering 28 Tera-FLOPS and calculation peak performance of 28 trillion times.

High Energy Efficiency

- Hard disks can be powered on at different times to reduce startup power consumption.
- Dynamic energy conservation and power capping are used to minimize power consumption.
- The 1.2 V DDR4 DIMMs consume 20% less energy than DDR3 DIMMs.

Technical Specifications

Form factor	Full-height dual-socket server node occupying two slots
Number of Processors	1 or 2
Processor	Intel® Xeon® E5-2600 v3/v4 processor
Memory	16 DDR4 DIMM slots
Local storage	Four 2.5-inch SSDs or SAS/SATA HDDs Two Mini SSDs (SATA DOMs) One USB flash drive
Network Ports	2 x GE, 4 x GE, 2 x 10GE, 2 x GE+2 x 10GE, 2 x 10GBase-T or 2 x 56G IB
PCIe Expansion	Up to 5 PCIe slots
OSs Supported	Citrix XenServer Microsoft Windows Server Oracle Enterprise Linux Oracle Server VM Red Hat Enterprise Linux SUSE Linux Enterprise Server VMware ESXi
Operating temperature*	5°C to 40°C (41°F to 104°F)
Certifications	CE, UL, FCC and RoHS
Dimensions(H x W x D)	166 mm x 109 mm x 670 mm

HUAWEI FusionServer XH628 V3



The XH628 V3 is a full-height dual-socket server node occupying two slots in an X6800 server. It uses the Intel[®] Xeon[®] E5-2600 v3/v4 series processors and supports 16 DDR4 memory slots. An XH628 V3 server node can be configured with twelve 3.5-inch SAS/SATA HDDs or 2.5-inch SSDs or SAS/SATA HDDs and two 2.5-inch SSDs or SATA HDDs. The XH628 V3 server nodes can be used in Huawei ES3000 storage acceleration solution and apply to applications, such as cloud computing, data centers, and big data applications.

High Density

- The server nodes share the fan modules and PSUs in the chassis, minimizing space requirements.
- The 4U high-density architecture occupies 50% less space than a traditional 2U rack server.

Large Capacity

- An XH628 V3 supports up to four Huawei ES3000 PCIe cards and offers 1.56 million IOPS, which is equivalent to 1500 mainstream SAS HDDs.
- A 4U server can hold four XH628 V3 server nodes, which offer a maximum capacity of 400 TB.
- An XH628 V3 supports RAID 0, 1, 1E, 10, 5, 50, 6, and 60 and a wide range of RAID controller cards. It provides a RAID cache and uses a supercapacitor to protect cache data from power failures.

Efficient O&M

- Provides an iBMC web management interface and UID/HLY indicators to help maintenance personnel quickly locate faults.
- Supports remote maintenance functions, such as SOL, KVM over IP, virtual media, and WebUI, to implement remote deployment and maintenance.
- Supports alarm notifications via email and short messages and performs automatic service restoration to minimize system risks.
- Supports Network Controller Sideband Interface (NC-SI), which allows a network port to
 provide functions of both a management network port and a service port. This feature
 reduces the number of ports and cables and simplifies the management system.
- Uses modular design and allows cable-free installation and maintenance, increasing deployment and O&M efficiency.

Technical Specifications

Form factor	Full-height dual-socket server node occupying two slots
Number of Processors	1 or 2
Processor	Intel [®] Xeon [®] E5-2600 v3/v4 processor
Memory	16 DDR4 DIMM slots
Local storage	Twelve 3.5-inch SAS/SATA HDDs or 2.5-inch SSDs or SAS/SATA HDDs Two 2.5-inch SSDs or SATA HDDs (optional) Two Mini SSDs (SATA DOMs) One USB flash drive
Network Ports	2 x GE, 4 x GE, 2 x 10GE, 2 x GE+2 x 10GE, 2 x 10GBase-T or 2 x 56G IB
PCIe Expansion	Up to 5 PCIe slots
OSs Supported	Citrix XenServer, Microsoft Windows Server, Oracle Enterprise Linux, Oracle Server VM, Red Hat Enterprise Linux, SUSE Linux Enterprise Server, VMware ESXi
Operating temperature*	5°C to 40°C (41°F to 104°F)
Certifications	CE, UL, FCC and RoHS
Dimensions(H x W x D)	166 mm x 109 mm x 745 mm

Copyright © Huawei Technologies Co., Ltd. 2015. All rights reserved.

No part of this document may be reproduced or transmitted in any form or by any means without prior written consent of Huawei Technologies Co., Ltd.

Trademark Notice

HUAWEI, and **W** are trademarks or registered trademarks of Huawei Technologies Co., Ltd. Other trademarks, product, service and company names mentioned are the property of their respective owners.

General Disclaimer

The information in this document may contain predictive statements including, without limitation, statements regarding the future financial and operating results, future product portfolio, new technology, etc. There are a number of factors that could cause actual results and developments to differ materially from those expressed or implied in the predictive statements. Therefore, such information is provided for reference purpose only and constitutes neither an offer nor an acceptance. Huawei may change the information at any time without notice.

HUAWEI TECHNOLOGIES CO., LTD.

Huawei Industrial Base Bantian Longgang Shenzhen 518129, P.R. China Tel: +86-755-28780808 Version No.: M3-035260-20150513-C-3.0

www.huawei.com